C 26889

Name	····
Reg. No	

FOURTH SEMESTER B.TECH. (ENGINEERING) DEGREE EXAMINATION MAY 2012

EC 09 406/PTEC 09 405—SOLID STATE DEVICES

Time: Three Hours Maximum: 70 Marks

Part A

Short answer questions.

- 1. What is the significance of Fermi-Dirac function?
- 2. What is avalanche breakdown?
- 3. Why is BJT called current controlled device?
- 4. What is kirk effect?
- 5. What is strong inversion in MOSFET?

 $(5 \times 2 = 10 \text{ marks})$

Part B

Answer any four questions.

- 6. Derive the expression for charge concentrations of semiconductor doped with pentavalent impurity.
- 7. Derive the expression for drift current in semiconductors.
- 8. Derive the expression for built in potential of a graded PN junction.
- 9. With circuit diagram explain and write the expressions for terminal currents of p-n-p BJT.
- 10. Explain the short-channel effects in MOSFET.
- 11. Explain the concept of threshold voltage in N-MOSFET and P-MOSFET.

 $(4 \times 5 = 20 \text{ marks})$

Part C

12. (a) Derive the continuity equation.

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- (b) Derive the expression for Fermi-level in intrinsic semiconductor.
- 13. (a) Explain Schottky effect and derive an expression for change in potential barrier due to image charge and applied bias voltage.

Or

- (b) Draw the structure of GaAs isotope diodes and explain its characteristics.
- 14. (a) Draw the Eber-Moll model for BJT and write the analytical expressions for transistor characteristics.

Or

- (b) Draw the structure of JFET and explain its operation.
- 15. (a) Explain the working and characteristics of n-channel, depletion MOSFET with diagrams.

Or

(b) Explain the working of floating gate MOSFET with diagram.

 $(4 \times 10 = 40 \text{ marks})$